



## HTE-5356 **High Temperature Epoxy**

Thermally Conductive, Low Viscosity, Potting Compound for Electrical Applications

HANDLING & CURING	
Mix Ratio by Weight, resin: hardener	100:25
Specific Gravity, gms/cc @25 ℃	1.95
Mixed Viscosity, cP @25 °C	3,000
Pot Life, 100 gm mass @25 ℃, hrs	>8
Recommended Cure, hr/°F	2/160 +2/300
Alternate Cure, hr/ °F	6/250
CURED PROPERTIES	
Temperature Resistance, °F	-67/+365
Temperature Resistance, °C	-55/+185
CTE, in/in/°F x 10 <sup>-6</sup> (°C)	18.9 (34.0)
Thermal Conductivity, Btu-in/hr-ft <sup>2</sup> - °F	8.4
Tensile Shear Strength, psi*1	-
Flexural Strength, psi	12,300
Volume Resistivity, ohms-cm	1.0 x 10 <sup>16</sup>
Dielectric Strength, volts-mils	480
Dielectric Constant, 1.0 kHz	4.7
Dissipation Factor	.01
Chemical Resistance	Excellent
Hardness, Shore D	92
Color	Black
Cure Shrinkage, in/in*2	.003
*1 Tested according to ASTM D1002-94. This is a method for deter *2 Linear shrinkage is measured using a ¾ lb casting mass.	rmining the shear strength of a single lap-joint metal coupons in tension loading.

## **General Information**

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

## **Shelf Life**

This product has a six months minimum shelf life after date of manufacture, unless otherwise specified, in original, unopened containers.

## Note

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